A 216–256 GHz fully differential frequency multiplier-by-8 chain with 0 dBm output power

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Abstract

This work presents a fully differential wideband and low power 240 GHz multiplier-by-8 chain, manufactured in IHP’s 130 nm SiGe:C BiCMOS technology with $f_{\text{T}}/f_{\text{max}} = 300/500$ GHz. A single ended 30 GHz input signal is multiplied by 8 using Gilbert cell-based quadrupler and doubler, and then amplified with a wideband differential 3-stage cascode amplifier. To achieve wide bandwidth and optimize for power consumption, the power budget has been designed in order to operate the frequency multipliers and the output amplifier in saturation. With this architecture the presented circuit achieves a 3 dB bandwidth of 40 GHz, meaning a relative 3 dB bandwidth of 17%, and a peak saturated output power of 0 dBm. Harmonic rejections better than 25 dB were measured for the 5th, 6th, and 7th harmonics. It dissipates 255 mW from 3 V supply which results in drain efficiency of 0.4%, while occupying 1.2 mm². With these characteristics the presented circuit suits very well as a frequency multiplier chain for driving balanced mixers in 240 GHz transceivers for radar, communication, and sensing applications.

Introduction

Wide-band frequency multiplier chains with sufficient output power above 200 GHz are of immense importance used as transmitters or to drive the mixer’s local oscillator (LO) port in transceivers chip-sets. The main challenges for such circuits are to achieve flat frequency response with as high DC-to-RF efficiency as possible and filtering out the unwanted harmonics. Different solutions have been proposed to realize such circuits. Fundamental frequency oscillators at 240 GHz [1] or at 120 GHz followed by a frequency doubler [2], although being power-efficient solutions, they are accompanied by constraints and tradeoffs concerning the phase noise due to the degraded quality factor of varactors at such frequencies. Also, in coherent systems when LO synchronization is required, the design of a phase locked loops divider (PLL) becomes a challenge. A second solution is the multiplication of a low frequency signal performed by LO chain consisting of cascaded frequency multipliers [3,4]. The latter option suits well for applications requiring wide tuning range and LO synchronization. It also allows for the usage of available PLLs at lower frequencies with optimized phase noise performance. The later solution might be more power consuming due to the multi-stage nature of such circuits. An efficient power budget distribution becomes of high importance to achieve acceptable power efficiency. Maximum power efficiency is achieved when the different stages are at the onset of saturation. Another point to consider when designing high multiplication factor LO chain is the LO spurs, which is critical for wideband communication systems as the spurious LO signal might lead to parasitic noise folding and unwanted image signals down-converted on top of the desired signal. That explains why the inter-stage matching circuits within the LO chain need to be carefully designed and centered within the band in order to reject spurious unwanted harmonics and frequency intermodulation products.

To enhance the achievable output power, power combining of multipliers array has been proposed in the literature where power combining might be either on-chip or wireless [5,6]. In this work LO multiplier-by-8 chain is presented, aiming to deliver 0 dBm of power, which is typically sufficient to saturate active double-balanced Gilbert cell mixers, across wide bandwidth with a fully differential architecture. This paper is organized as follows: in the section “Circuit design”, the LO chain architecture and the design details are discussed. The section “Measurement results” provides the measurement results and the section “Conclusion” concludes the paper.

Circuit design

LO multiplication chain architecture

As shown in Fig. 1, a single ended 30 GHz signal ($LO_m$) is fed through a spiral Marchand balun to a single stage Gilbert cell-based frequency quadrupler. The output is amplified by...
a single stage cascode amplifier which drives a 240 GHz frequency doubler, the die photo of this test structure is shown in Fig. 2(a). In a second version of the LO chain an output wideband amplifier is deployed in order to achieve 0 dBm output power, where the die photo of the full LO chain is shown in Fig. 2(b). Marchand baluns at 240 GHz were utilized in both versions to allow for on wafer measurements. The design is implemented in a standard 0.13 nm SiGe:C BiCMOS technology from IHP. The technology offers hetero-junction bipolar transistors (HBT) with a cutoff frequency and maximum frequency of oscillation of 300 GHz and 500 GHz, respectively. It has two thick metal layers: TopMetal2 (TM2) and TopMetal1 (TM1) with 3 and 2 µm thickness, respectively, and five thin metal layers made of Aluminum.

Wideband 30 GHz Marchand balun

To enable the use of differential architecture, a spiral planar edge-coupled Marchand balun, shown in Fig. 3, was implemented at the input. The balun is designed using the top metal layer (3 µm thick) with a ground plane at a distance of 8.1 µm. The conductor width (W) and spacing (S) of 4 µm each were chosen to achieve both wide band operation without sacrificing the ripple in the insertion loss at the middle of the band, and a good input return loss (S11) across the whole band, as explained in [7,8]. Another important aspect when designing the conductor width is the self-resonance of the whole structure, caused by the parasitic capacitance in between the turns. An inductive compensation structure at the input (Lcomp) compensates for the pad capacitance (Cpad). Simulation results show an amplitude and phase imbalance of ±0.5 dB and ±2.5° within the band 10–50 GHz as shown in Fig. 4. Also the insertion loss for the differential mode (Diff.) and common mode (CM) to single ended input (SE) shows a rejection of approximately 25 dB across the whole band.

A back-to-back test structure, shown in Fig. 3, was manufactured and measured, the measurement results in Fig. 5 show a 3-dB bandwidth of 38.5 GHz from 14 to 52.5 GHz, with a fractional BW of 116 % and a minimum insertion loss of 2.35 dB. The S11 is below −8 dB across the 3-dB bandwidth. The balun occupies an area of 260 µm × 150 µm.

120 GHz frequency quadrupler design

Different architectures have been proposed in the literature to implement frequency quadruplers, frequency doublers have been either cascaded [4] or stacked in order to reduce the power consumption by reusing the bias current [9]. The latter solution, although has a low power consumption and larger bandwidth because of the less number of stages, it suffers from low output power due to the limited output power from the input push-push doublers which subsequently does not saturate the second switching quad. In order to achieve low-power consumption and
sufficient output power, a novel architecture is implemented in this work where a compact frequency quadrupler based on a single Gilbert cell converts a 30 GHz input frequency directly into 120 GHz. It consists of a quadrupler core and an output buffer. The Gilbert cell core shown in Fig. 6(a), which is conventionally utilized as a doubler, generates strong fourth harmonic by emphasizing the nonlinearities (3rd harmonic) of the transconductance stage ($Q_n - Q_p$) which then mixes with the fundamental tone within the switching quad. Although achieving lower DC power consumption compared with the cascaded linear multiplying doublers topology, the utilization of the input transconductance stage nonlinearities degrades the spurious performance of such an architecture. The output amplifier, shown in Fig. 6(b), behaves as a tuned filter at the fourth harmonic to reduce the unwanted 3rd and 5th harmonics. This can be observed in Fig. 7 where the simulated output power for the 3rd, 4th, and 5th harmonics are plotted across the input frequency. The output amplifier increased the rejection to the 3rd harmonic by 15 dB and to the 5th harmonic by 5 dB at 30 GHz input frequency. The circuit achieves an output power of 2.7 dBm at 120 GHz with a 3 dB bandwidth of 25 GHz, and a drain efficiency of 4.1%.

240 GHz frequency doubler design

Although the push-push frequency doubler architecture allows for higher power efficiency [2], it requires a balun at the output in order to drive double-balanced Gilbert cell mixers. The balun phase and gain imbalance are translated into common mode excitation for the mixer which degrades the LO to RF isolation, this is crucial especially for direct conversion transmitters. On top of that, single-ended signaling causes poor supply and ground noise rejection, and possible feedback loops. For these reasons a fully differential Gilbert cell-based doubler, shown in Fig. 8(a), is utilized in this work to keep the differential architecture of the LO chain [4,10]. As the frequency doubler is normally in the large signal mode of operation, hence the input transistors ($Q_n - Q_p$) and the switching quad transistors ($Q_1 - Q_4$) are sized for maximum $f_T$ based on the under drive current consumption.

The core of the frequency doubler is optimized to reduce the parasitic capacitance between the input of the switching quad transistors ($Q_3 - Q_4$) and the doubler’s differential output, highlighted as $C_{par}$ in Fig. 8(a). This is critical at such high frequencies because large $C_{par}$ might lead to a leaking input signal to the output and so significantly deteriorates the doubler conversion gain. Full electromagnetic (EM) simulation is used as shown in Fig. 8(b) to capture the spurious leakage accurately. For the sake of better output signal differentiality a degeneration resistor $R_{deg}$ of 10 Ω is utilized to degenerate the common mode signal. With optimized signal routing within the doubler core, phase and gain imbalance of <5° and 1 dB respectively, were simulated across the whole band of interest as shown in Fig. 9. In order to minimize the conversion loss of the doubler, the transmission lines ($TL_1 - TL_2$) are optimized to keep a 90° phase shift between the input base voltage and emitter current to the switching quad, taking into account the effect of the parasitic inductance within the doubler core.

A 3 dB bandwidth of 60 GHz with a maximum output power of ~6 dBm ($P_{in} = 0$ dBm) was simulated for the doubler with good in/out matching as shown in Fig. 10(a). While the power sweep in Fig. 10(b) for $F_{out} = 240$ GHz shows that conversion...
gain of $-6.2$ dB is achieved at an input power of $-3$ dBm, while the output power achieves approximately 0 dBm at an input power of 8 dBm, dissipating a power consumption of 27 mW. This leads to maximum drain efficiency of 3.7%.

### 240 GHz amplifier design

In order to deliver a power level of 0 dBm, a fully differential 240 GHz amplifier offering about 10 dB gain was placed at the...
output of the LO chain, as in the second version of the LO chain shown in Fig. 1. The used 240 GHz amplifier is a fully differential 3-stage cascode with Guanella impedance transformers [11], used for input and output matching and transformer-based inter-stage matching. An amplifier schematic view is reported in Fig. 11(a). A mid-size transistor has been chosen for trade-off between power consumption, output power and gain. The collectors have been biased through the transformers’ center tap, using an additional 10 $\Omega$ bias resistor $R_b$ for avoiding inter-stage feedbacks through the supply lines. The transformers have been designed making extensive use of EM simulations. Input and output matching have been performed with the help of Guanella impedance transformers, which transforms in a wideband fashion the reference impedance of 100–25 $\Omega$, closer to the amplifier’s input and output impedances. In other words, through a Guanella transformer the 100 $\Omega$ reference impedance at which the amplifier has to be matched can be lowered within the whole band of interest by a factor 4–25 $\Omega$, an impedance which is close to the one shown by base, for input matching, and collector, for output matching, of the core transistors. In order to verify its performance, the amplifier has been manufactured and measured as a stand-alone circuit, and its die photo is shown in Fig. 11(b). For measurement purposes, the differential input and output must be converted by integrated Marchand baluns to single ended signals. A WR-3.4 (220–325 GHz) vector network analyzer frequency extension modules have been used to characterize the amplifier. In Fig. 12 on-wafer measurement and simulations of the stand-alone amplifier are compared in terms of S-parameters. The high degree of agreement validates the design procedure. Within a bandwidth as wide as 50 GHz, a gain of 9 dB has been measured, at a power consumption of 100 mW.

**LO chain power budget**

To explore the power budget across the LO chain, Fig. 13 shows the simulated power level at the output of each stage across the input power. It is clear that the highest efficiency will be achieved if each and every block is operating at the onset of saturation, but few dBs as a margin is crucial when planning systems at such frequencies. It can be observed that the LO chain saturates at input power of approximately $-4$ dBm, where the doubler drives the doubler with $-2$ dBm. The doubler drives the amplifier with a power of $-8$ dBm, which guarantee that the whole chain is operating at the onset of saturation with some margin, leading to a saturated output power of approximately 0 dBm.

![Fig. 11. Schematic (a) and die photo (b) of the 240 GHz amplifier.](image)

![Fig. 12. Measured and simulated S-parameters of the 240 GHz amplifier.](image)
Measurement results

At first the LO chain without the output amplifier (Version 1), whose die photo is shown in Fig. 2(a), was measured on wafer. An external low-frequency source was applied at the input of the multiplier-by-8 chain varying its frequency and power level, while the output power was measured using an absolute power meter (Erickson calorimeter PM4). A saturated output power of $-8$ dBm was measured with a 3 dB BW of 32 GHz as shown in Fig. 14(a). A wider bandwidth of 40 GHz was measured for the full LO chain with the amplifier (Version 2), shown in Fig. 2(b), with a saturated output power of 0 dBm as shown in Fig. 14(b). These power levels were compensated for the probe loss of 3 dB but not for the on chip balun and pad which contribute with a loss of approximately 1 dB each.

Output LO harmonics of the frequency multiplier chain were measured on wafer within the G-Band frequency range, 140–220 GHz, in order to monitor the 5th, 6th, and 7th harmonics. The measurement results in Fig. 15 shows that the highest harmonic is the 7th harmonic with a 25 dB of rejection compared with the fundamental signal (8th harmonic) which was plotted in Fig. 14(a). Comparing the harmonics rejection of the first version with the one in the second version, it is clear that the external amplifier enhanced the rejection to the 5th and 6th harmonics as the frequencies are out of the amplifier effective bandwidth, while no enhancement can be observed in the 7th harmonic as its frequency range lies within the amplifier bandwidth. A better rejection of the 7th harmonic can be achieved by further filtering of the 3rd harmonic at the quadrupler output by adding extra tuned amplification stage. Good match between measurements and simulations is achieved through full EM simulation of different circuit parts. A temperature of 45°C was used in simulation to account for the real chip operation temperature. Table 1 compares this work with state-of-the-art single element LO chains and frequency sources above 200 GHz. With a 3 dB bandwidth of 40 GHz and saturated output power of 0 dBm the presented LO chain provides the highest bandwidth with such output power and inherently differential outputs when compared to the state-of-the-art. It suits well as LO chain to feed balanced Gilbert cell mixer in transceiver’s front ends. By utilizing a VCO with 5 GHz of tuning range at 30 GHz and average phase noise (PN) of $-100$ dBc/Hz at 10 MHz offset frequency [14], locked frequency sources of 40 GHz bandwidth in the 240 GHz frequency band and estimated phase noise of $-102$ dBc/Hz at 10 MHz offset ($PN_{240GHz} = PN_{300GHz} + 20\log(8)$), can be realized.

Conclusion

In this paper, a fully differential 240 GHz frequency multiplier-by-8 chain has been presented. A frequency quadrupler followed by a doubler multiplies a 30 GHz input signal by 8. An output amplifier operating in the saturation region is deployed to amplify
the doubler output, enhancing the achieved bandwidth and increase the harmonics rejection. The frequency source achieved 3 dB bandwidth of 40 GHz with saturated output power of 0 dBm. The worst case harmonic rejection is 25 dB for the 7th harmonic, while the 5th and 6th harmonics were rejected by more than 40 dB. The circuit dissipates 255 mW, from a 3 V supply, and occupies 1.2 mm². With this performance, the presented frequency source is well suited as LO chain to drive balanced Gilbert cell mixers for a variety of wideband communication and imaging applications.

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References


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Table 1. Comparison of integrated local oscillator multiplier chains above 200 GHz

<table>
<thead>
<tr>
<th>Circuit</th>
<th>Output type</th>
<th>Frequency [GHz]</th>
<th>3 dB BW (GHz)</th>
<th>POUt (dBm)</th>
<th>Harmonic rejection (dB)</th>
<th>DC-to-RF efficiency (%)</th>
<th>Area (mm²)</th>
<th>PDC (mW)</th>
</tr>
</thead>
<tbody>
<tr>
<td>+X2</td>
<td>SE</td>
<td>245</td>
<td>22</td>
<td>8.9</td>
<td>18.6%</td>
<td>11%</td>
<td>11%</td>
<td>11.7%</td>
</tr>
<tr>
<td>+X2</td>
<td>Diff.</td>
<td>215</td>
<td>40</td>
<td>8.9</td>
<td>18.6%</td>
<td>11%</td>
<td>11%</td>
<td>11.7%</td>
</tr>
<tr>
<td>+X2</td>
<td>SE</td>
<td>247.5</td>
<td>27</td>
<td>8.9</td>
<td>18.6%</td>
<td>11%</td>
<td>11%</td>
<td>11.7%</td>
</tr>
<tr>
<td>+X2</td>
<td>Diff.</td>
<td>227.5</td>
<td>25</td>
<td>8.9</td>
<td>18.6%</td>
<td>11%</td>
<td>11%</td>
<td>11.7%</td>
</tr>
<tr>
<td>+X2</td>
<td>Diff.</td>
<td>255</td>
<td>30</td>
<td>8.9</td>
<td>18.6%</td>
<td>11%</td>
<td>11%</td>
<td>11.7%</td>
</tr>
<tr>
<td>+X2</td>
<td>Diff.</td>
<td>236</td>
<td>40</td>
<td>8.9</td>
<td>18.6%</td>
<td>11%</td>
<td>11%</td>
<td>11.7%</td>
</tr>
</tbody>
</table>

*Not compensated for on chip balun and output pad loss of approximately 1 dB each. n.a.: not available.

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